



# HB-LED NA TC Chapter

SEMICON West 2018 Meetings

Monday, July 09

San Francisco, California

9:00AM – 10:00AM

## AGENDA

	<b>Time</b>
<b>1 Welcome/Call to Order</b>	<b>09:00-09:10</b>
1.1 Introductions	
1.2 Required Meeting Elements (Membership Requirements, Antitrust and Intellectual Property Reminders, and Effective Meeting Guidelines)	
1.3 Agenda Review	
<b>2 Review of Previous Meeting Minutes (including open Action Items review)</b>	<b>09:10-09:15</b>
<b>3 Staff Report</b>	<b>09:15-09:20</b>
<b>4 Liaison Reports</b>	<b>09:20-09:30</b>
4.1 Korea Chapter Formation Group (CFG)	
4.2 China TC Chapter	
<b>5 Ballot Review (including Safety and IP Checks)</b>	<b>09:30-09:35</b>

#	When	TF	Details
6387	Cycle 5-2018	n/a	Reapproval to SEMI HB2-0613, <i>Specification for 150 mm Open Plastic and Metal Wafer Cassettes Intended for Use for Manufacturing HB-LED Devices</i>



<b>6 Subcommittee &amp; Task Force Reports (including leadership and TF changes)</b>	<b>09:35-09:40</b>
6.1 HB-LED Wafer TF	
6.2 Patterned Sapphire Substrate (PSS) TF	
6.3 HB-LED Source Materials TF	
<b>7 Old Business</b>	<b>09:40-09:45</b>
7.1 Standards due for Five-Year Review	
7.2 SNARFs approaching Three-Year Document Development Project Period	
<b>8 New Business</b>	<b>09:45-09:50</b>
8.1 New TFOF(s) and SNARF(s)	
8.2 Ballot Authorizations	
8.3 Upcoming Ballot(s)	
<b>9 New Action Item Review</b>	<b>09:50-09:55</b>
<b>10 Next Meeting (Fall 2018, at SEMI HQ, Milpitas, CA)</b>	<b>09:55-10:00</b>
Thursday, Nov 8, 2018 (Tentative)	
• HB-LED Joint Wafer/Source Materials / PSS / Eqt Communication TFs (9:00-10:30)	
• NA HB-LED TC Chapter (10:30 – Noon)	
<b>11 Adjournment</b>	<b>10:00</b>

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